

Vishay Siliconix

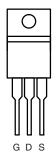
RoHS

COMPLIANT

N-Channel 75 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{(BR)DSS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ)		
75	0.0082 at V_{GS} = 10 V	90 ^d	58		



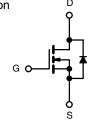




- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- 100 % R_g and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Power Supply
 Secondary Synchronous Rectification
- Industrial



N-Channel MOSFET

Top View Ordering Information: SUP90N08-8m2P-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATING	S (T _C = 25 °C, unless oth	nerwise noted)			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	75	V		
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current (T ₁ = 175 °C)	T _C = 25 °C	1-	90 ^d	А	
Continuous Drain Current $(1) = 175$ C)	T _C = 70 °C	I _D	79 ^d		
Pulsed Drain Current		I _{DM}	200	А	
Avalanche Current	I _{AS}	50			
Single Avalanche Energy ^a L = 0.1 mH		E _{AS}	125	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	Р	150 ^b	w	
	T _A = 25 °C ^c	– P _D –	3.75		
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W
Junction-to-Case (Drain)	R _{thJC}	1	0/11

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

d. Package limited.

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SPECIFICATIONS ($T_J = 25$	°C, unless o	otherwise noted)					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	75			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.8		4.8	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	μΑ	
		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	70			А	
		V _{GS} = 10 V, I _D = 20 A		0.0069	0.0082	0	
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.0116	0.014	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A		55		S	
Dynamic ^b	•		•				
Input Capacitance	C _{iss}			3528		pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 30 V, f = 1 MHz		470			
Reverse Transfer Capacitance	C _{rss}			178			
Total Gate Charge ^c	Qg			58	90		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 38 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 15 \text{ A}$		21		nC	
Gate-Drain Charge ^c	Q _{gd}			16			
Gate Resistance	Rg	f = 1 MHz		1.8	3.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			21	35		
Rise Time ^c	t _r	V_{DD} = 38 V, R_L = 3.1 Ω		15	25		
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 12.5 A, V_GEN = 10 V, R_g = 1 Ω		32	55	ns	
Fall Time ^c	t _f			10	20		
Source-Drain Diode Ratings and Cha	racteristics T	_C = 25 °C ^b	•				
Continuous Current	ا _S				83		
Pulsed Current	I _{SM}				200	A	
Forward Voltage ^a	V _{SD}	$I_{F} = 30 \text{ A}, V_{GS} = 0 \text{ V}$		0.85	1.5	V	
Reverse Recovery Time	t _{rr}			61	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 75 A, di/dt = 100 A/μs		2.7	4.5	А	
Reverse Recovery Charge	Q _{rr}			83	140	nC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

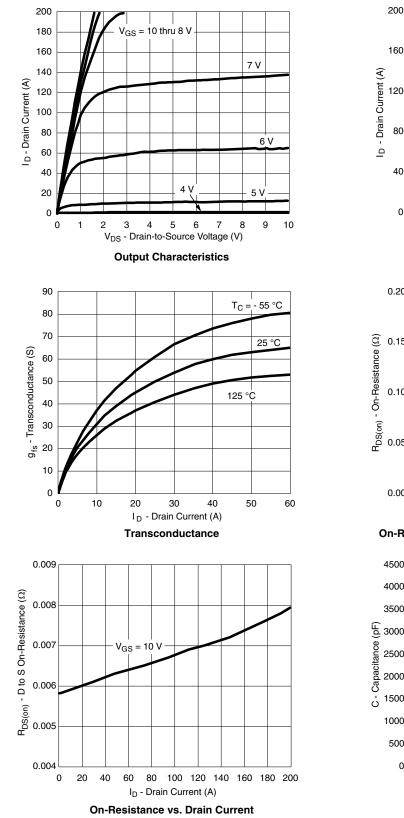
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

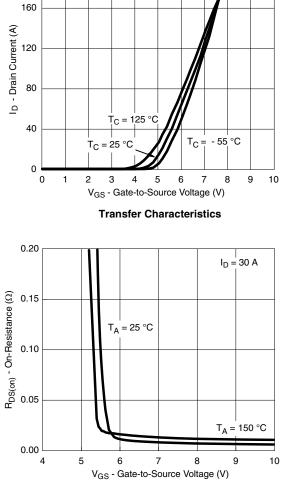
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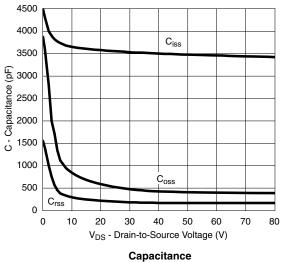
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Gate-to-Source Voltage vs.Temperature

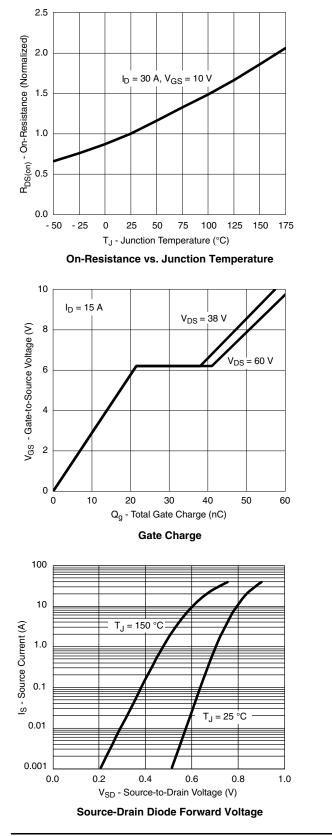


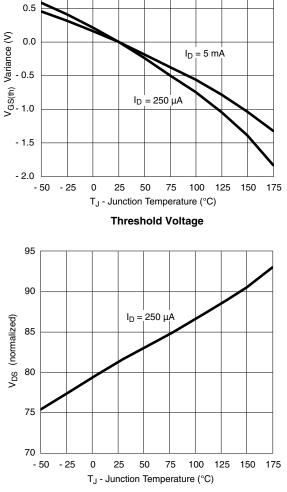
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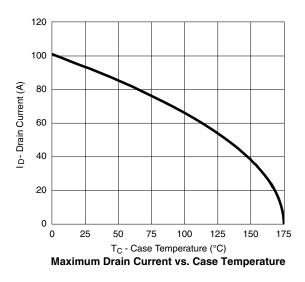
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1.0

Drain Source Breakdown vs. Junction Temperature

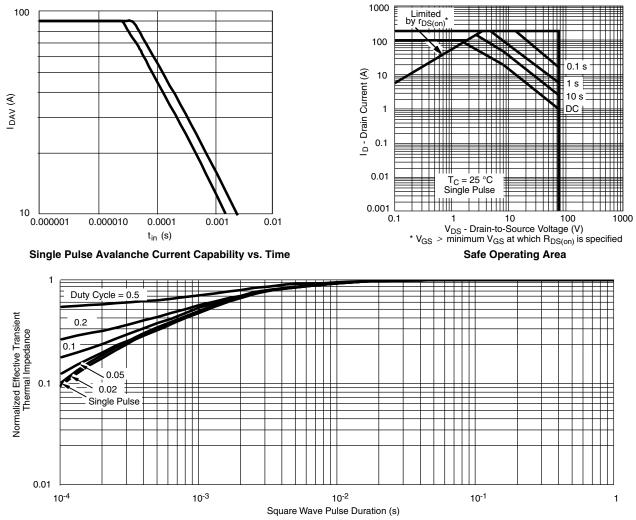


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg269615.

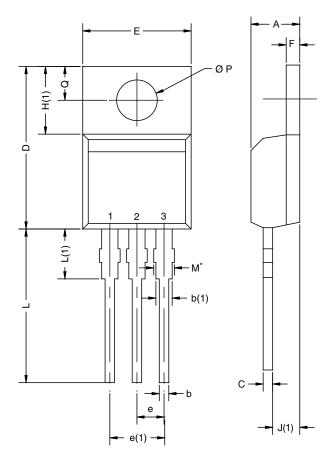
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TO-220AB



	MILLIMETERS		INC	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T13- DWG: 547	0724-Rev. O, 1	14-Oct-13			

Note

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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